

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE01H13 uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

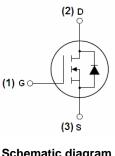
- V_{DS} =100V,I_D =130A $R_{DS(ON)}$ <6.8m Ω @ V_{GS} =10V (Typ:5.3m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H13	NCE01H13	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Gate-Source Voltage Drain Current-Continuous Drain Current-Continuous(T _C =100°C) Pulsed Drain Current Maximum Power Dissipation	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V _G S	±20	V	
Drain Current-Continuous	I _D	130	А	
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	92	Α	
Pulsed Drain Current	I _{DM}	500	Α	
Maximum Power Dissipation	P _D	285	W	
Derating factor		1.9	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	1100	mJ	



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NCE01H13

Parameter	Symbol	Limit	Unit			
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C			
Thermal Characteristic						
Thermal Resistance, Junction-to-Case (Note 2)	R _{eJC}	0.53	°C/W			

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	_S =100V,V _{GS} =0V -		1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3.0	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	5.3	6.8	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	40	-	-	S
Dynamic Characteristics (Note4)			1			
Input Capacitance	C _{lss}		-	7100	-	PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,	-	413	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	333	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	31	-	nS
Turn-on Rise Time	t _r	V _{DD} =50V, R _L =2.5Ω	-	24	-	nS
Turn-Off Delay Time	$t_{\sf d(off)}$	V_{GS} =10V, R_{GEN} =3 Ω	-	45	-	nS
Turn-Off Fall Time	t _f		-	27	-	nS
Total Gate Charge	Qg	\/ F0\/ OFA	-	170	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =50V,I _D =65A,	-	38	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	65	-	nC
Drain-Source Diode Characteristics	<u>.</u>					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	130	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	65	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	110	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE				y LS+LD)

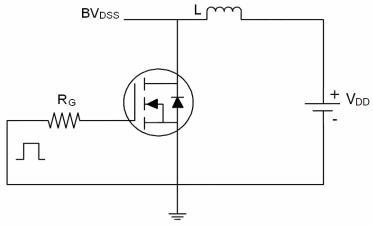
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition:Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=1mH,Rg=25 Ω

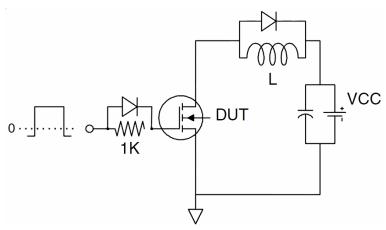


Test Circuit

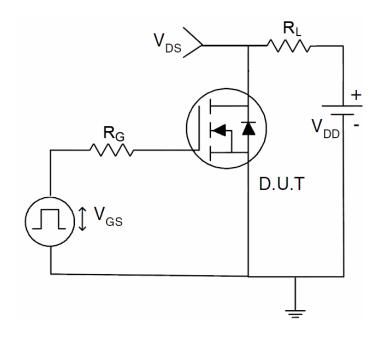
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

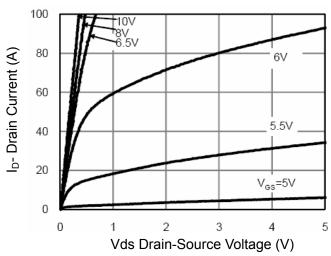


Figure 1 Output Characteristics

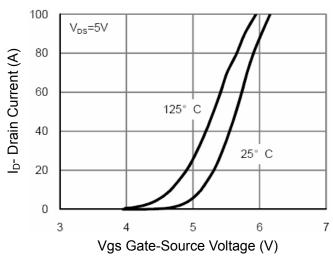


Figure 2 Transfer Characteristics

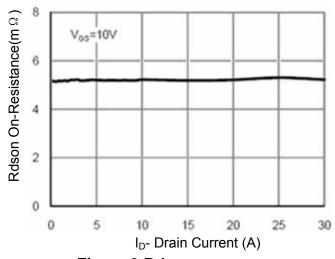


Figure 3 Rdson- Drain Current

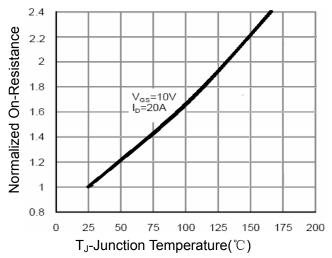


Figure 4 Rdson-JunctionTemperature

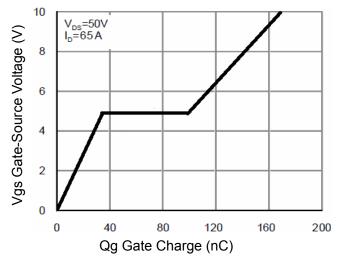


Figure 5 Gate Charge

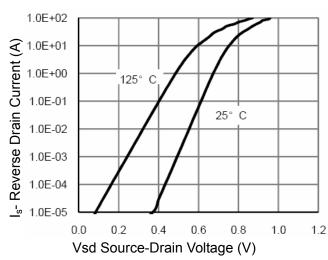
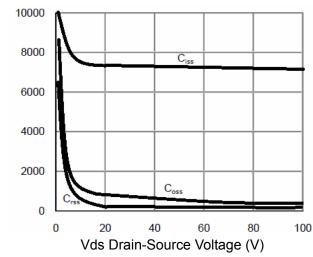
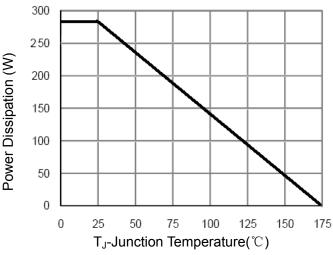


Figure 6 Source- Drain Diode Forward



C Capacitance (pF)





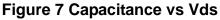
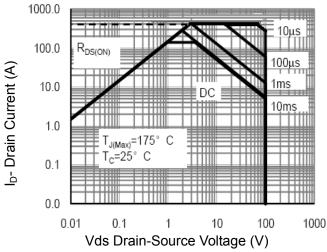


Figure 9 Power De-rating



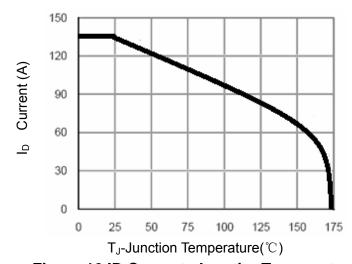


Figure 8 Safe Operation Area

Figure 10 ID Current- JunctionTemperature

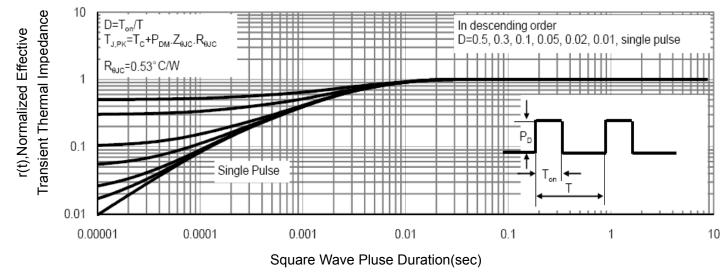
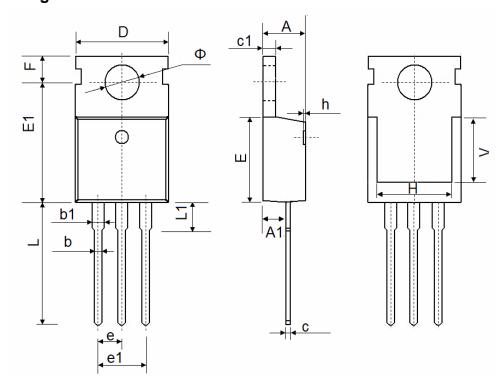


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information



Complete	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	REF.	0.295 REF.		
Ф	3.400	3.800	0.134	0.150	

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